BB301C

Build in Biasing Circuit MOS FET IC
VHF RF Amplifier

HITACHI

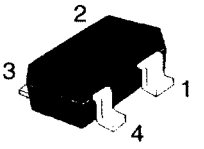
ADE-208-507
1st. Edition

Features

- Build in Biasing Circuit; To reduce using parts cost & PC board space.
- Low noise characteristics; (NF = 1.3 dB typ. at f = 200 MHz)
- Withstanding to ESD; Build in ESD absorbing diode . Withstand up to 200 V at C = 200 pF, Rs = 0 conditions.

Outline

CMPAK–4



1. Source
2. Gate1
3. Gate2
4. Drain

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DS}	6	V
Gate 1 to source voltage	V_{G1S}	+6 –0	V
Gate 2 to source voltage	V_{G2S}	±6	V
Drain current	I_D	25	mA
Channel power dissipation	Pch	100	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

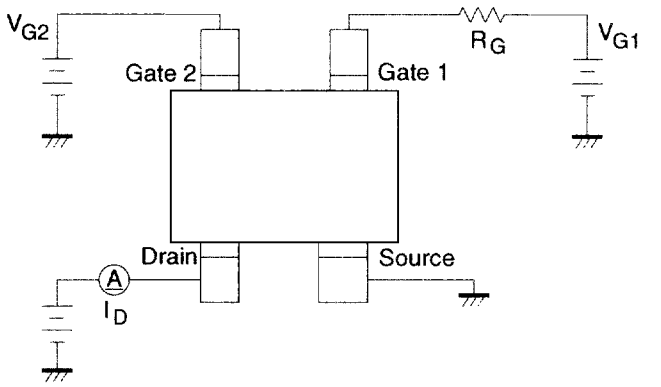
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	6	—	—	V	I_D = 200 µA $V_{G1S} = V_{G2S} = 0$
Gate 1 to source breakdown voltage	$V_{(BR)G1SS}$	+6	—	—	V	I_{G1} = +10 µA $V_{G2S} = V_{DS} = 0$
Gate 2 to source breakdown voltage	$V_{(BR)G2SS}$	±6	—	—	V	I_{G2} = ±10 µA $V_{G1S} = V_{DS} = 0$
Gate 1 to source cutoff current	I_{G1SS}	—	—	+100	nA	V_{G1S} = +5 V $V_{G2S} = V_{DS} = 0$
Gate 2 to source cutoff current	I_{G2SS}	—	—	±100	nA	V_{G2S} = ±5 V $V_{G1S} = V_{DS} = 0$
Gate 1 to source cutoff voltage	$V_{G1S(off)}$	0.4	—	1.0	V	V_{DS} = 5 V, V_{G2S} = 4 V I_D = 100 µA
Gate 2 to source cutoff voltage	$V_{G2S(off)}$	0.4	—	1.0	V	V_{DS} = 5 V, V_{G1S} = 5 V I_D = 100 µA
Drain current	$I_{D(op)}$	10	15	20	mA	V_{DS} = 5 V, V_{G1} = 5 V V_{G2S} = 4 V, R_G = 100 kΩ
Forward transfer admittance	$\lvert y_{fs} \rvert$	15	20	—	mS	V_{DS} = 5 V, V_{G1} = 5 V V_{G2S} = 4 V R_G = 100 kΩ, f = 1 kHz
Input capacitance	Ciss	2.2	3.0	4.0	pF	V_{DS} = 5 V, V_{G1} = 5 V V_{G2S} = 4 V, R_G = 100 kΩ f = 1 MHz
Output capacitance	Coss	0.9	1.2	1.6	pF	
Reverse transfer capacitance	Crss	—	0.018	0.04	pF	
Power gain	PG	22	26	—	dB	V_{DS} = 5 V, V_{G1} = 5 V V_{G2S} = 4 V
Noise figure	NF	—	1.3	1.9	dB	R_G = 100 kΩ, f = 200 MHz

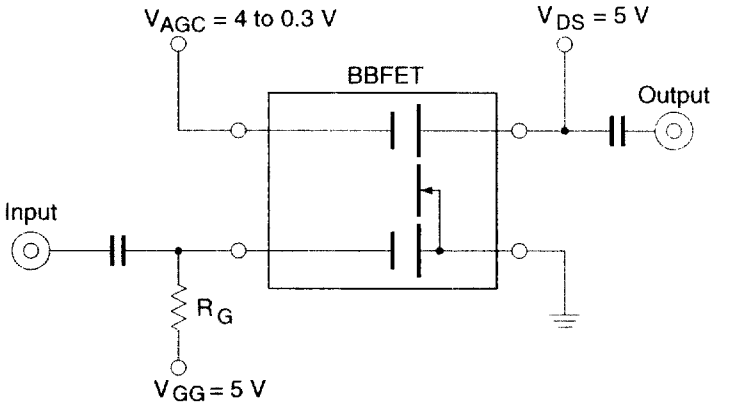
Note: Marking is "AW–".

Main Characteristics

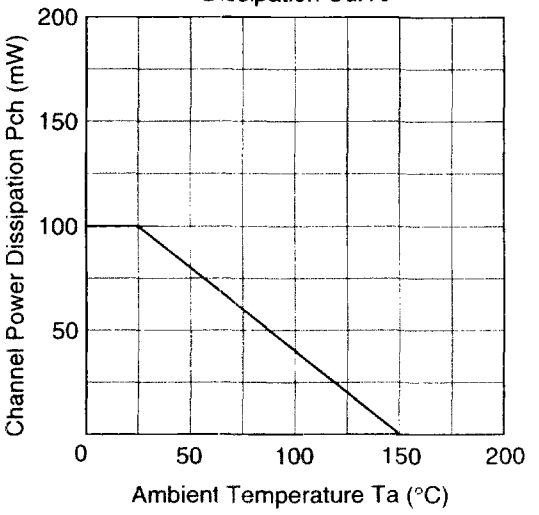
Test Circuit for Operating Items ($I_{D(op)}$, $|y_{fs}|$, Ciss, Coss, Crss, NF, PG)



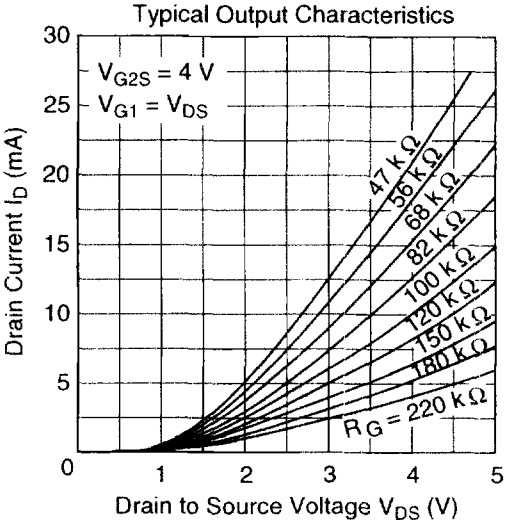
Application Circuit



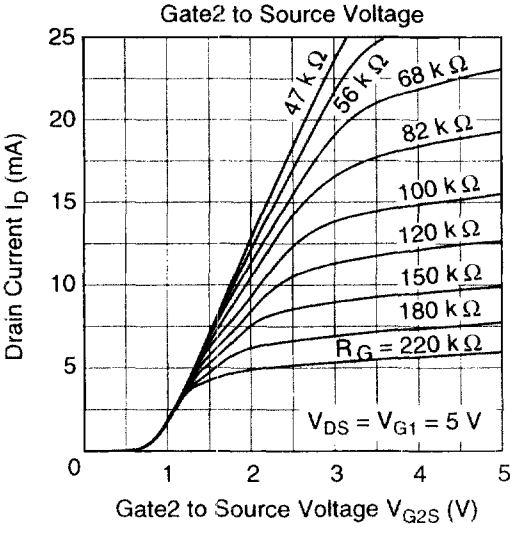
Maximum Channel Power Dissipation Curve



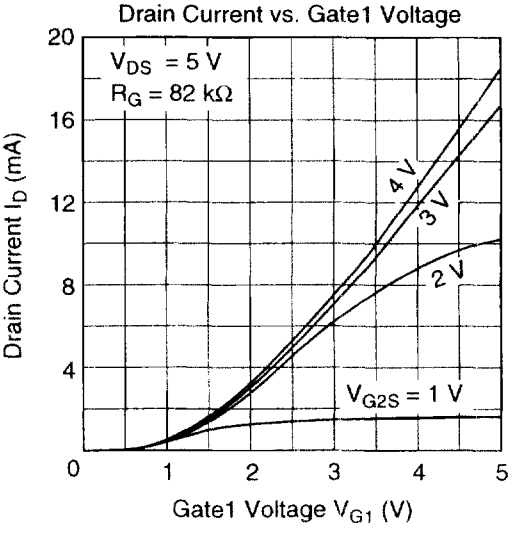
Typical Output Characteristics



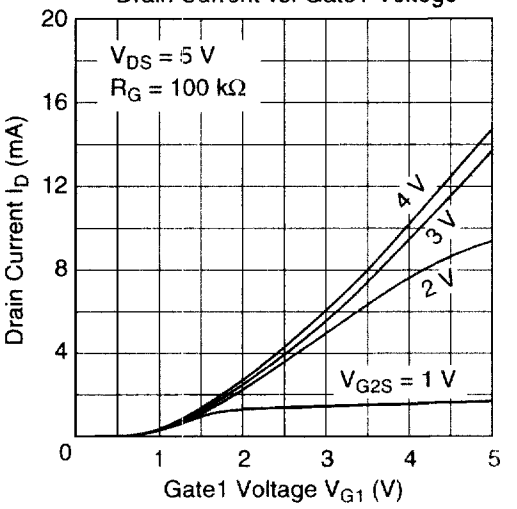
Drain Current vs. Gate2 to Source Voltage



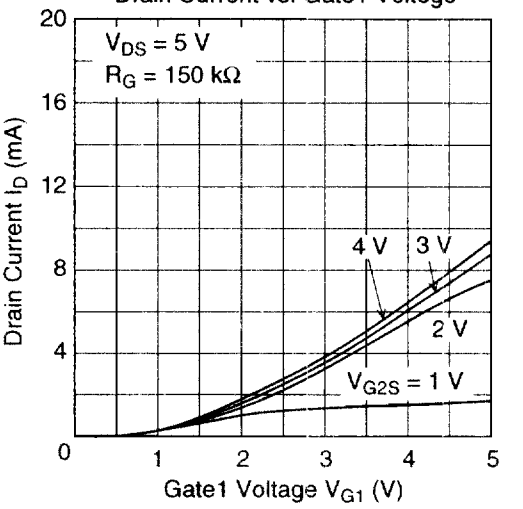
Drain Current vs. Gate1 Voltage



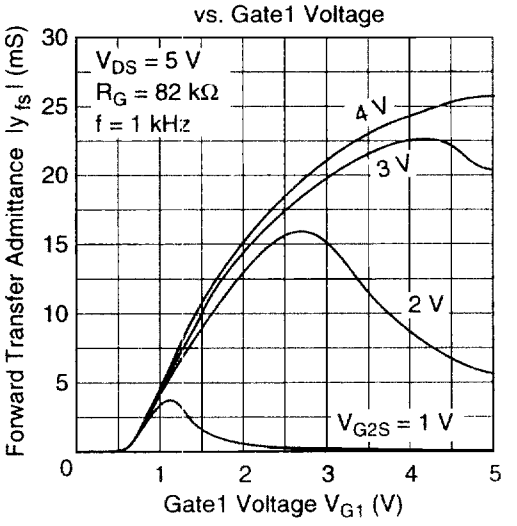
Drain Current vs. Gate1 Voltege



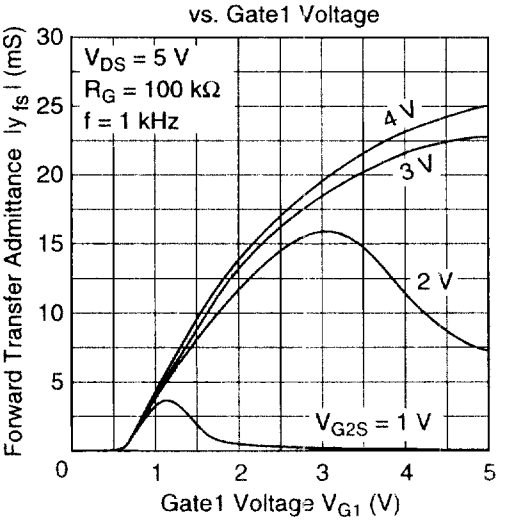
Drain Current vs. Gate1 Voltege



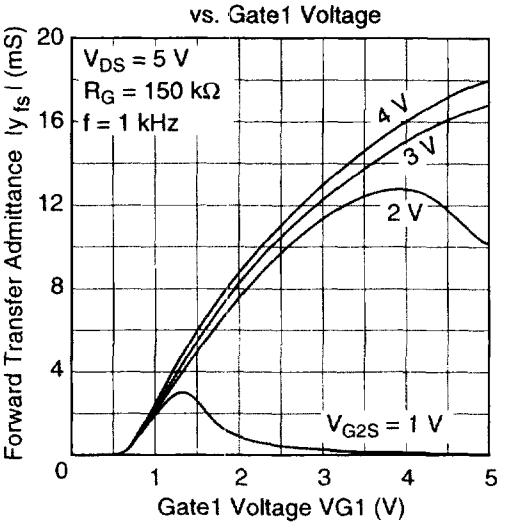
Forward Transfer Admittance vs. Gate1 Voltage



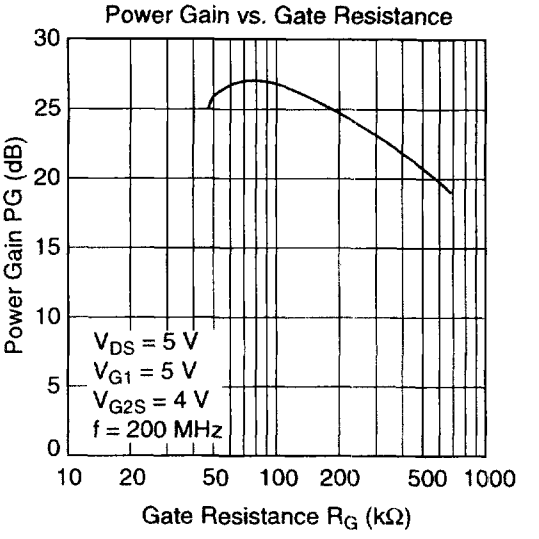
Forward Transfer Admittance vs. Gate1 Voltage



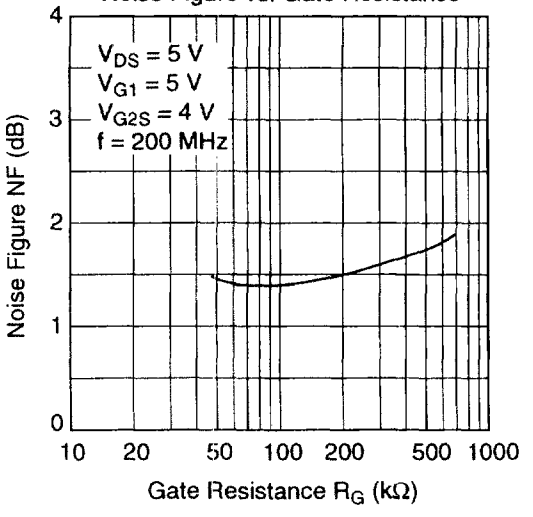
Forward Transfer Admittance vs. Gate1 Voltage



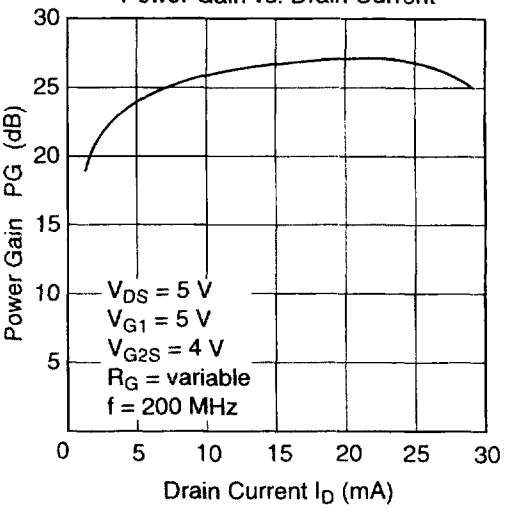
Power Gain vs. Gate Resistance



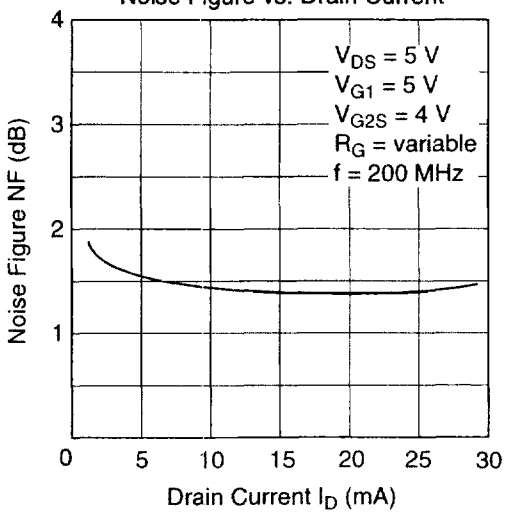
Noise Figure vs. Gate Resistance



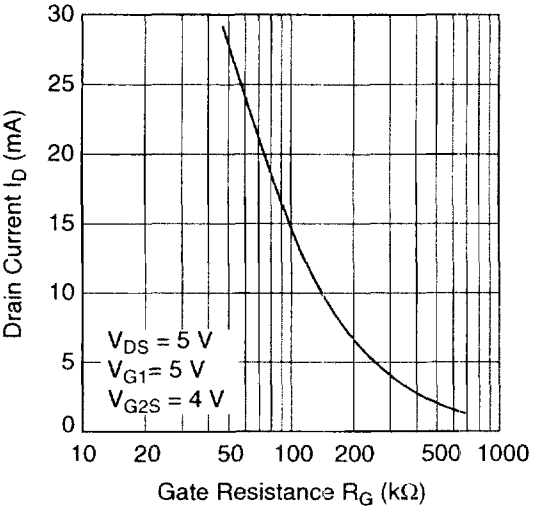
Power Gain vs. Drain Current



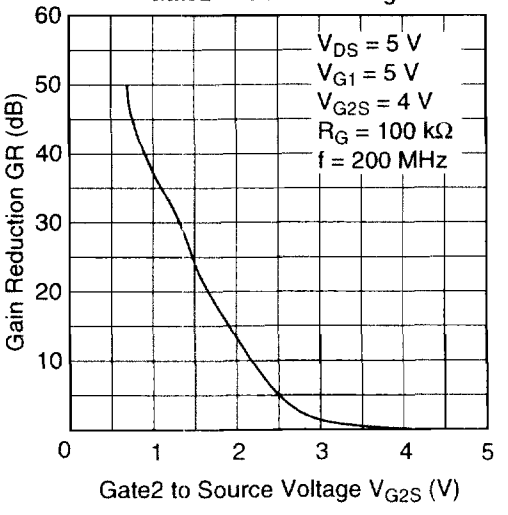
Noise Figure vs. Drain Current



Drain Current vs. Gate Resistance



Gain Reduction vs.
Gate2 to Source Voltage



Input Capacitance vs.
Gate2 to Source Voltage